

STARPOWER

SEMICONDUCTOR

IGBT

GD200HFY120C2S

1200V/200A 2 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

Features

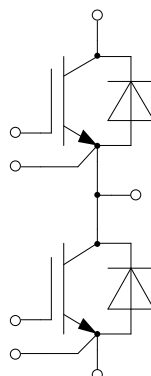
- Low $V_{CE(sat)}$ Trench IGBT technology
- Low switching loss
- 10 μ s short circuit capability
- Low inductance case
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	330	A
	@ $T_C=100^{\circ}\text{C}$	200	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	400	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	1103	W

Diode

Symbol	Description	Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	200	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	400	A

Module

Symbol	Description	Values	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	4000	V

IGBT Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.65	2.10	V
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=125^{\circ}\text{C}$		1.95		
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		2.00		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=5.00\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.2	6.0	6.8	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			1.0		Ω
C_{ies}	Input Capacitance	$V_{CE}=30\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		18.2		nF
C_{res}	Reverse Transfer Capacitance			0.56		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		1.20		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=200\text{A}, R_G=3.0\Omega, V_{GE}=\pm 15\text{V}, T_j=25^{\circ}\text{C}$		213		ns
t_r	Rise Time			64		ns
$t_{d(off)}$	Turn-Off Delay Time			280		ns
t_f	Fall Time			180		ns
E_{on}	Turn-On Switching Loss			4.10		mJ
E_{off}	Turn-Off Switching Loss			16.3		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=200\text{A}, R_G=3.0\Omega, V_{GE}=\pm 15\text{V}, T_j=125^{\circ}\text{C}$		285		ns
t_r	Rise Time			78		ns
$t_{d(off)}$	Turn-Off Delay Time			363		ns
t_f	Fall Time			278		ns
E_{on}	Turn-On Switching Loss			7.40		mJ
E_{off}	Turn-Off Switching Loss			23.0		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=200\text{A}, R_G=3.0\Omega, V_{GE}=\pm 15\text{V}, T_j=150^{\circ}\text{C}$		293		ns
t_r	Rise Time			81		ns
$t_{d(off)}$	Turn-Off Delay Time			374		ns
t_f	Fall Time			327		ns
E_{on}	Turn-On Switching Loss			8.70		mJ
E_{off}	Turn-Off Switching Loss			25.2		mJ
I_{SC}	SC Data	$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}, V_{CC}=900\text{V}, V_{CEM} \leq 1200\text{V}$		800		A

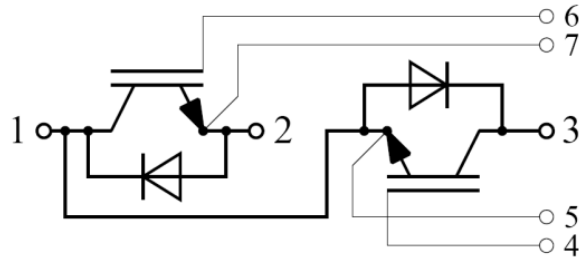
Diode Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_C=200\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		2.15	2.55	V
		$I_C=200\text{A}, V_{GE}=0\text{V}, T_j=125^{\circ}\text{C}$		2.20		
		$I_C=200\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		2.15		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=200\text{A},$ $-di/dt=2750\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^{\circ}\text{C}$		16.2		μC
I_{RM}	Peak Reverse Recovery Current			169		A
E_{rec}	Reverse Recovery Energy			10.2		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=200\text{A},$ $-di/dt=2750\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^{\circ}\text{C}$		24.4		μC
I_{RM}	Peak Reverse Recovery Current			204		A
E_{rec}	Reverse Recovery Energy			16.2		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=200\text{A},$ $-di/dt=2750\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^{\circ}\text{C}$		31.4		μC
I_{RM}	Peak Reverse Recovery Current			222		A
E_{rec}	Reverse Recovery Energy			19.4		mJ

Module Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

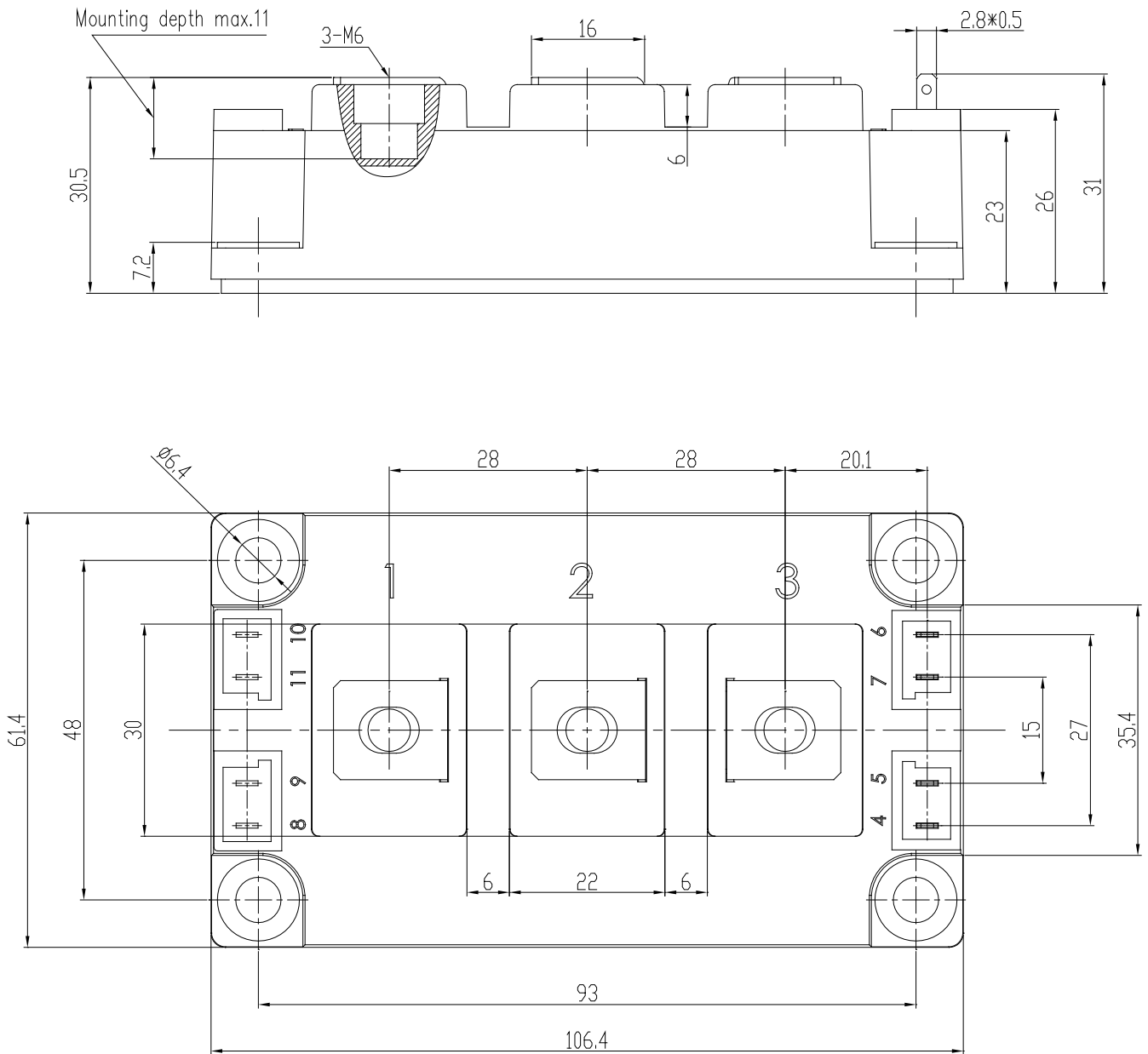
Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance			20	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.35		m Ω
R_{thJC}	Junction-to-Case (per IGBT)			0.136	K/W
	Junction-to-Case (per Diode)			0.194	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.060		K/W
	Case-to-Heatsink (per Diode)		0.085		
	Case-to-Heatsink (per Module)		0.035		
M	Terminal Connection Torque, Screw M6	2.5		5.0	N.m
	Mounting Torque, Screw M6	3.0		5.0	
G	Weight of Module		300		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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